



Title of Change:	Transfer of Automotive Assembly and Test operations of SMB packaged products to ON Semiconductor Vietnam (OSV).
Proposed Changed Material First Ship Date:	1 July 2018 <i>or earlier upon customer approval</i>
Current Material Last Order Date:	1 April 2018 Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability.
Current Material Last Delivery Date:	30 June 2018 The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory.
Product Category:	<i>Active components – Discrete components</i>
Contact information	Contact your local ON Semiconductor Sales Office or <Phuong.Hoang@onsemi.com>
Samples	Contact your local ON Semiconductor Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification.
Sample Availability Date:	1 July 2017
PPAP Availability Date:	31 July 2017
Additional Reliability Data	Contact your local ON Semiconductor Sales Office or <cheanching.sim@onsemi.com>.
Type of Notification	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 12 months prior to implementation of the change or earlier upon customer approval. ON Semiconductor will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 45 days of delivery of this notice. To do so, contact < PCN.Support@onsemi.com >.
Change Category	Type of Change
Process – Assembly	Move of all or part of assembly to a different location/site/subcontractor.
Test Flow	Move of all or part of electrical wafer test and/or final test to a different location/site/subcontractor.
Equipment	Production from a new equipment/tool which uses the same basic technology (replacement equipment or extension of existing equipment pool) without change of process.

Description and Purpose:

This Final Notification announces the transfer of Assembly and Test of SMB products from ON Semiconductor Malaysia (SBN) to ON Semiconductor Vietnam (OSV).

The OSV part numbers are available to early adaptors for immediate SBN demand conversion. Customer can view a list of those OSV part numbers, cross referenced to the transferring SBN part numbers listed in the attached Excel file.

Upon completion of this transfer, SMB demand will be sourced solely from OSV and will no longer be available from SBN. At that time, either the transferring SBN or the current OSV part numbers can be utilized to order these products from OSV.

ON Semiconductor Vietnam (OSV) is qualified site for SMB Standard discrete packaged products and is ISO TS16949 certified.

Products sourced from OSV have been qualified to Automotive requirements and continue remain as Pb-free, Halide free and RoHS compliant.

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List of affected Parts:

Transferring Malaysia (SBN) Part Number	Qualification Vehicle
SZ1SMB5936BT3G	P6SMB200AT3G
SZ1SMB5937BT3G	
SZ1SMB5914BT3G	
SZ1SMB5927BT3G	
SZ1SMB5939BT3G	
SZ1SMB5920BT3G	
SZ1SMB5924BT3G	
SZ1SMB5933BT3G	